TOSHIBA Field Effect Transistor Silicon P-Channel MOS Type ($L^2-\pi$ -MOSV)

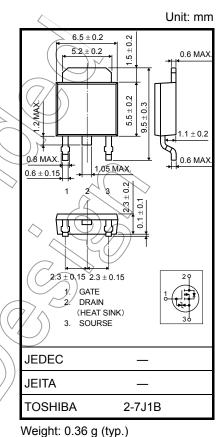
2SJ377

Relay Drive, DC/DC Converter and Motor Drive Applications

- 4 V gate drive
- Low drain-source ON-resistance : $R_{DS (ON)} = 0.16 \Omega$ (typ.)
- High forward transfer admittance : |Y_{fs}| = 4.0 S (typ.)
- Low leakage current : $I_{DSS} = -100 \ \mu A \ (max) \ (V_{DS} = -60 \ V)$
- Enhancement mode : $V_{th} = -0.8$ to -2.0 V ($V_{DS} = -10$ V, $I_D = -1$ mA)

Absolute Maximum Ratings (Ta = 25°C)

Characteristic		Symbol	Rating	Unit
Drain-source voltage		V _{DSS}	-60	V
Drain-gate voltage (R _{GS} = 20 kΩ)		V _{DGR}	-60	X
Gate-source voltage		V _{GSS}	±20	> v
Drain current	DC (Note 1)	Ι _D	-5	А
	Pulse (Note 1)	I _{DP}	-20	A
Drain power dissipation (Tc = 25°C)		PD <	20	XV
Single-pulse avalanche energy (Note 2)		EAS	273	Em
Avalanche current		LAR	-5	A
Repetitive avalanche energy (Note 3)			2	mJ
Channel temperature		Tch	150	0°C
Storage temperature range		(T _{stg}	-55 to 150	°C



Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings. Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc.).

Thermal Characteristics

Characteristic Symbol	Мах	Unit
Thermal resistance, channel to case Rth (ch-c)	6.25	°C / W
Thermal resistance, channel to ambient Rth (ch-a)	125	°C / W

Note 1: Ensure that the channel temperature does not exceed 150°C.

Note 2: $V_{DD} = -25 \text{ V}$, $T_{ch} = 25^{\circ}\text{C}$ (initial), L = 14.84 mH, $R_G = 25 \Omega$, $I_{AR} = -5 \text{ A}$

Note 3: Repetitive rating: pulse width limited by maximum channel temperature

This transistor is an electrostatic-sensitive device. Handle with care.

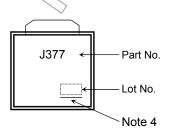
Electrical Characteristics (Ta = 25°C)

Chara	cteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Gate leakage cu	ırrent	I _{GSS}	V _{GS} = ±16 V, V _{DS} = 0 V	_	_	±10	μA
Drain cutoff curr	ent	IDSS	$V_{DS} = -60 \text{ V}, V_{GS} = 0 \text{ V}$		_	-100	μA
Drain-source bre	eakdown voltage	V (BR) DSS	I_D = -10 mA, V_{GS} = 0 V	-60	_	_	V
Gate threshold v	voltage	V _{th}	V _{DS} = -10 V, I _D = -1 mA	-0.8	_	-2.0	V
Drain-source ON-resistance		R _{DS (ON)}	$V_{GS} = -4 V$, $I_D = -2.5 A$	(L)	0.24	0.28	Ω
			V _{GS} = -10 V, I _D = -2.5 A		0.16	0.19	
Forward transfe	r admittance	Y _{fs}	V _{DS} = -10 V, I _D = -2.5 A	2.0	4.0	_	S
Input capacitance	e	C _{iss}			630		
Reverse transfe	r capacitance	C _{rss}	V _{DS} = -10 V, V _{GS} = 0 V, f = 1 MHz		95	_	pF
Output capacita	nce	C _{oss}		_	290		
Switching time	Rise time	tr	$V_{\rm GS} \stackrel{0V}{}$	- (25	$>$ $ _{>}$	
	Turn-on time	ton	$\sim 10V$	$\langle \langle \rangle$	45) _	ns
	Fall time	t _f	$V_{DD} = -30V$		> 55	_	10
	Turn-off time	t _{off}	Duty $\leq 1\%$, t _W = 10 μ s) –	200	_	
Total gate charg plus gate-drain)	e (Gate-source	Qg		_	22	_	_
Gate-source cha	arge	Q _{gs}	$V_{DD} = -48 \text{ V}, V_{GS} = -10 \text{ V}, I_D = -5 \text{ A}$	—	16	—	nC
Gate-drain ("Mill	er") charge	Qgd		_	6	_	

Source-Drain Ratings and Characteristics (Ta = 25°C)

Characteristic	Symbol	Test Condition	Min	Тур.	Max	Unit
Continuous drain reverse current (Note 1)	IDR	-	_		-5	A
Pulse drain reverse current (Note 1)	I _{DRP}	-	_		-20	A
Forward voltage (diøde)		I _{DR} = –5 A, V _{GS} = 0 V	_	-	1.7	V
Reverse recovery time	trr	I _{DR} = −5 A, V _{GS} = 0 V		80	—	ns
Reverse recovery charge	Qrr	dl _{DR} / dt = 50 A / μS	_	0.1	_	μC

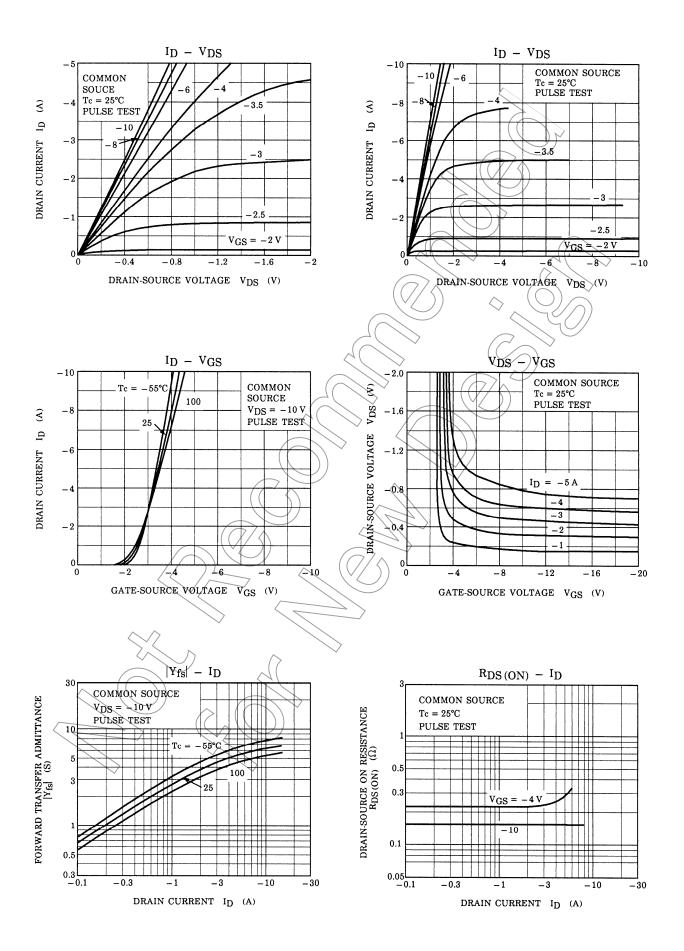
Marking



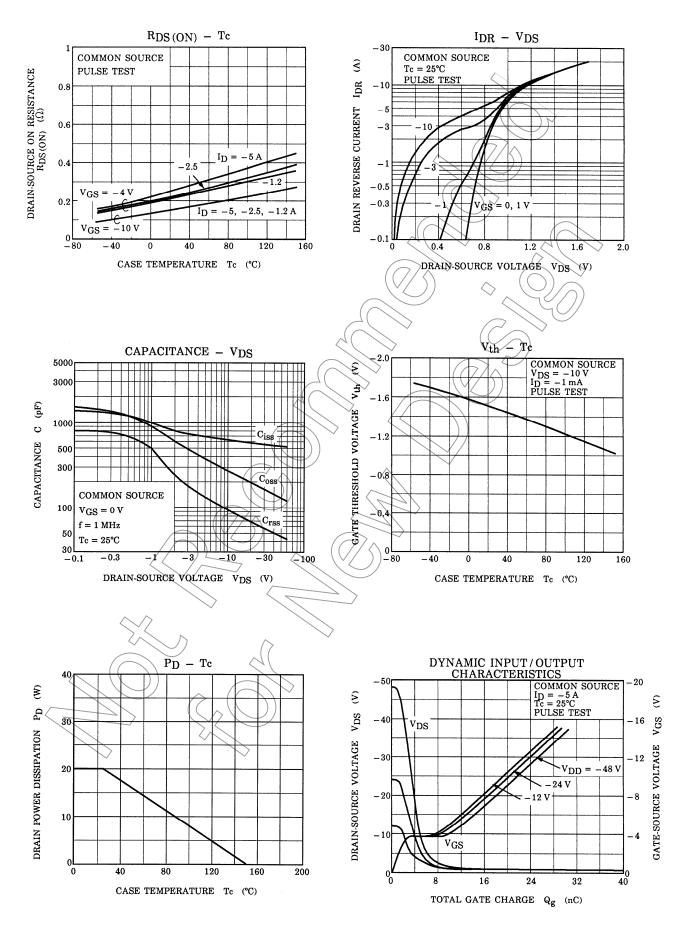
Note 4 : A line under a Lot No. identifies the indication of product Labels [[G]]/RoHS COMPATIBLE or [[G]]/RoHS [[Pb]]

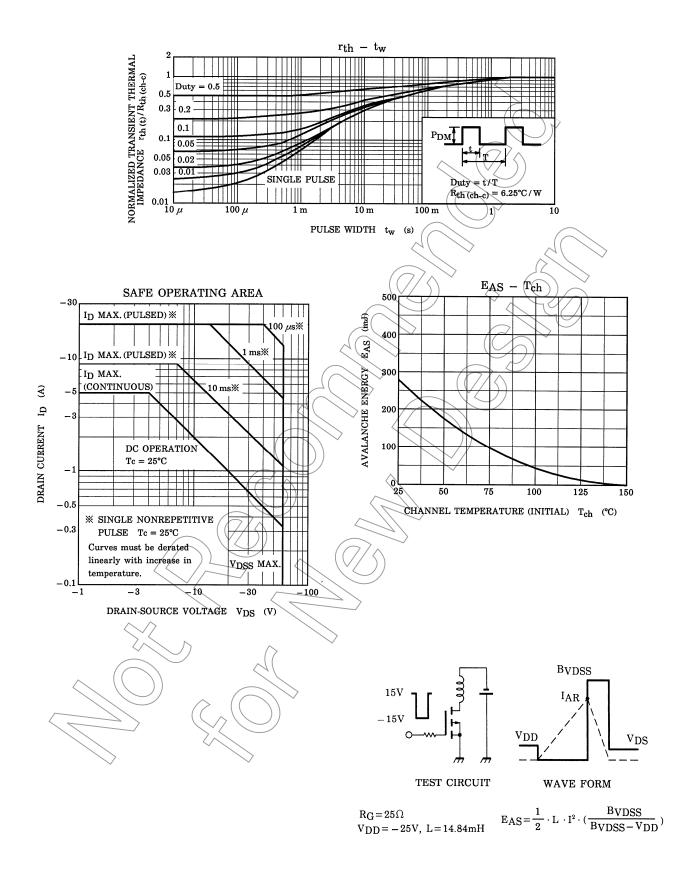
Please contact your TOSHIBA sales representative for details as to environmental matters such as the RoHS compatibility of Product. The RoHS is Directive 2002/95/EC of the European Parliament and of the Council of 27 January 2003 on the restriction of the use of certain hazardous substances in electrical and electronic equipment.

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